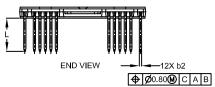
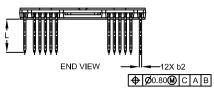
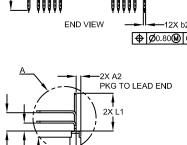


AHPM15-CDE AUTOMOTIVE MODULE CASE MODHT ISSUE O

DATE 23 APR 2021

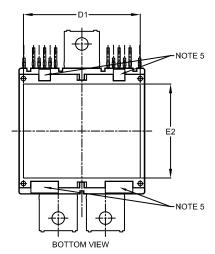


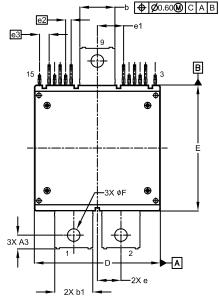


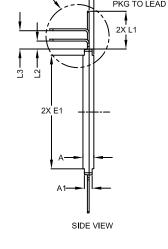




- 1. DIMENSIONING AND TOLERANCING PER. ASME Y14.5M, 2009.
- 2. CONTROLLING DIMENSION: MILLIMETERS
- 3. DIMENSIONS D & E DO NOT INCLUDE MOLD **PROTRUSIONS**
- 4. DIMENSIONS b,b1,b2 DO NOT INCLUDE DAMBAR REMAIN.
- 5. MARKING AREA.







♦ Ø0.60 M C A B		⊢ c]
TOP VIEW	И В-	<u> </u>	
		† <u></u>	1
END VIE	N		
	-12X b3 ──M°	// 0.07 C	▶ -C
<i>J</i> \		DETA	IL A

	MILLIMETERS		
DIM	MIN.	NOM.	MAX.
Α	4.60	4.80	5.00
A1	3.20	3.40	3.60
A2	1.70	2.05	2.40
A3	5.70	6.00	6.30
b	15.20	15.30	15.40
b1	16.50	16.60	16.70
b2	0.90	1.00	1.10
b3	0.50 REF		
С	0.70	0.80	0.90
D	54.80	55.00	55.20
D1	50.70	51.00	51.30
E	54.80	55.00	55.20

	MILLIMETERS		
D I M	MIN.	NOM.	MAX.
E1	49.40	49.60	49.80
E2	40.70	41.00	41.30
е	10.00	10.30	10.60
e1	11.15	11.45	11.75
e2	2.40 BSC		
e3	4.20 BSC		
F	5.40	5.50	5.60
L	14.17	14.47	14.77
L1	16.20	16.50	16.80
L2	3.20	3.50	3.80
L3	7.70	8.00	8.30
М	10° RFF		

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DESCRIPTION:	ON: AHPM15-CDE AUTOMOTIVE MODULE		PAGE 1 OF 2	

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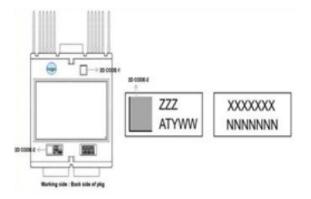
DETAIL B

AHPM15-CDE AUTOMOTIVE MODULE

CASE MODHT ISSUE O

GENERIC
MARKING DIAGRAM*

DATE 23 APR 2021



ZZZ = Assembly Lot Code

AT = Assembly & Test Location

= Year

WW = Work Week

XXXX = Specific Device Code

NNNN = Serial Number

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

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DESCRIPTION:	AHPM15-CDE AUTOMOTIVE MODULE		PAGE 2 OF 2	

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